



40V +175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI3333-8

Product Summary

BVDSS	R _{DS(ON)} Max	I _D Max T _C = +25°C
	15mΩ @ V _{GS} = 10V	27.5A
40V	25mΩ @ V _{GS} = 4.5V	22.0A

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature **Environments**
- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- Low RDS(ON) Ensures On-State Losses are Minimized
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

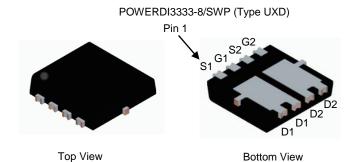
Description and Applications

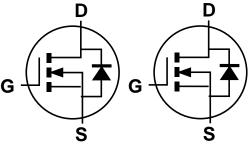
This MOSFET is designed to minimize the on-state resistance (RDS(ON)) vet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Wireless Charging
- **DC-DC Converters**
- Power Management

Mechanical Data

- Case: POWERDI®3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH4014LDVW-7	POWERDI3333-8/SWP (Type UXD)	2,000/Tape & Reel
DMTH4014LDVW-13	POWERDI3333-8/SWP (Type UXD)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>
 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



H4D = Product Type Marking Code YYWW = Date Code Marking \overline{YY} = Last Two Digits of Year (ex: 21 = 2021) WW = Week Code (01 to 53)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	40	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current, VGS = 10V (Note 6)		Tc = +25°C	ΙD	27.5	A
		T _C = +100°C		19.5	
Continuous Dunin Comment V 40V (Note C)	Steady	T _A = +25°C	————— In	10.2	А
Continuous Drain Current, V _{GS} = 10V (Note 6)	State	T _A = +100°C		7.2	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ірм	110	Α
Maximum Continuous Body Diode Forward Current (Note 6)			Is	3.7	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			lsм	110	Α
Avalanche Current, L = 0.1mH			las	19.8	Α
Avalanche Energy, L = 0.1mH			Eas	19.6	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.16	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	129	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.6	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	57.5	°C/W
Thermal Resistance, Junction to Case (Note 6)	R ₀ JC	7.8	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C	

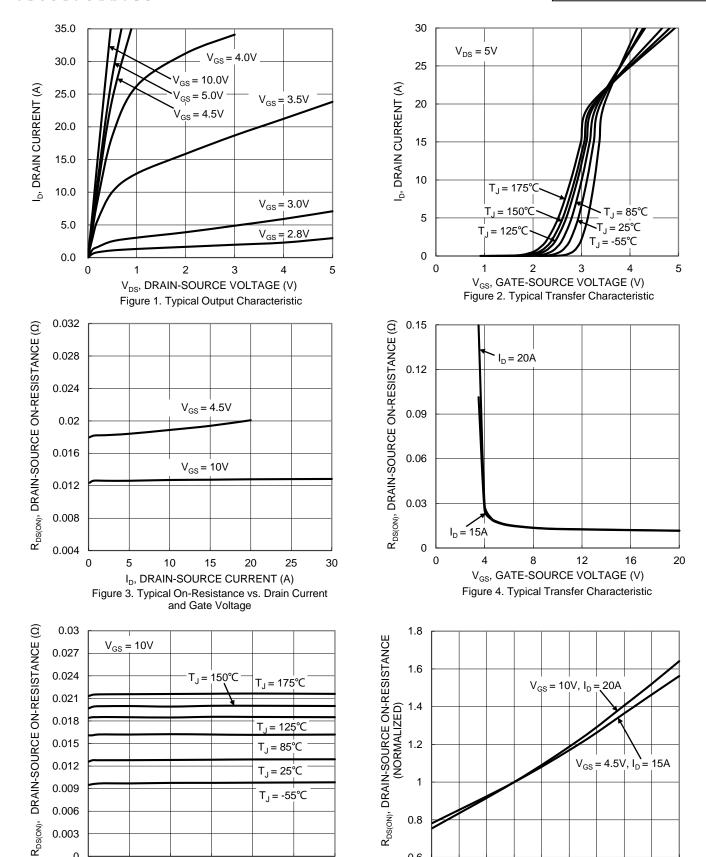
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 32V, V _{GS} = 0V	
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	12.8	15	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	RDS(ON)	_	19.4	25	11177	V _G S = 4.5V, I _D = 15A	
Diode Forward Voltage	VsD	_	1.0	1.2	V	Vgs = 0V, Is = 20A	
DYNAMIC CHARACTERISTICS (Note 8)			•		•		
Input Capacitance	Ciss	_	750	_	pF		
Output Capacitance	Coss	_	225	_	pF	V _{DS} = 20V, V _{GS} = 0V, -f = 1MHz	
Reverse Transfer Capacitance	Crss	_	21	_	pF T = TIMHZ		
Gate Resistance	Rg	_	1.1	_	Ω V _{DS} = 0V, V _{GS} = 0V, f = 1MHz		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.7	_	nC		
Total Gate Charge (VGS = 10V)	Qg	_	11.2	_	nC	7, 20,4 20,4	
Gate-Source Charge	Qgs	_	2.0	_	nC	$V_{DS} = 20V, I_{D} = 20A$	
Gate-Drain Charge	Q _{gd}	_	2.2	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	3.5	_	ns		
Turn-On Rise Time	t _R	_	4.6	_	ns	V _G S = 10V, V _{DD} = 20V,	
Turn-Off Delay Time	tD(OFF)	_	12.4	_	ns	$R_g = 1.6\Omega, I_D = 20A$	
Turn-Off Fall Time	t _F	_	4.9	_	ns	7 -	
Body Diode Reverse Recovery Time	trr	_	11.3	_	ns		
Body Diode Reverse Recovery Charge	Qrr	_	9.5	_	$\frac{1}{1}$ $\frac{1}$		

Notes: $\,$ 5. Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.

- 6. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





I_D, DRAIN CURRENT (A) Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

15

20

25

10

25 50

0.006

0.003 0

0

30

8.0

0.6

75 100 125 150 175



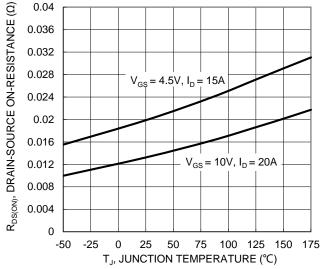


Figure 7. On-Resistance Variation with Temperature

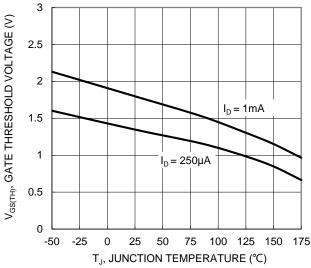


Figure 8. Gate Threshold Variation vs. Junction Temperature

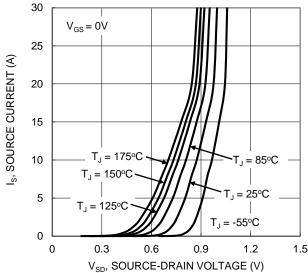
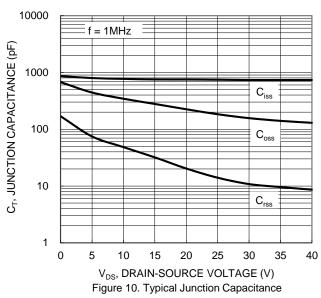
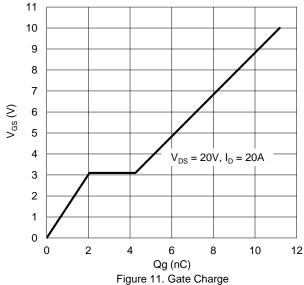


Figure 9. Diode Forward Voltage vs. Current



1000 $R_{DS(ON)}$ Limited $P_W = 100 \mu s$

P_W = 10ms



10 12 0.1 1 10 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

 $T_{J(Max)} = 175^{\circ}C$

T_C = 25°C

 $V_{GS} = 10V$

Single Pulse

DUT on 1*MRP Board

ID, DRAIN CURRENT (A)

10

0.1

0.01

100



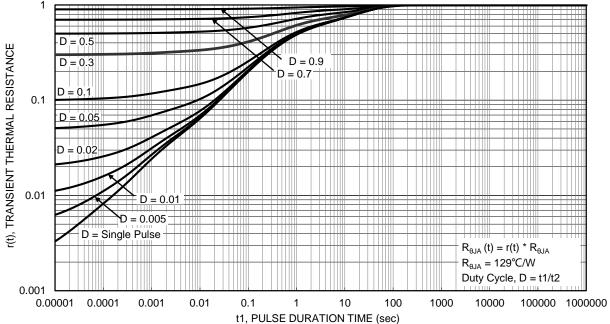


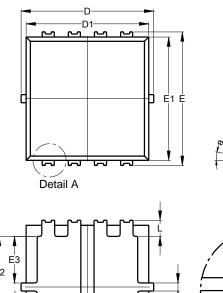
Figure 13. Transient Thermal Resistance

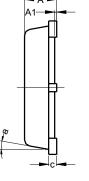


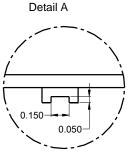
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI®3333-8/SWP (Type UXD)





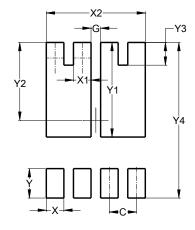


POWERDI®3333-8/SWP					
(Type UXD)					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	1.00	1.20	1.10		
Е	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E3	0.95	1.35	1.15		
E4	0.10	0.30	0.20		
е	_	_	0.65		
L	0.30	0.50	0.40		
k	0.50	0.90	0.70		
а	0°	12°	10°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI®3333-8/SWP (Type UXD)



E4

Dimensions	Value (in mm)
С	0.650
G	0.230
X	0.420
X1	0.420
X2	2.370
Υ	0.700
Y1	2.250
Y2	1.850
Y3	0.540
Y4	3.700



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